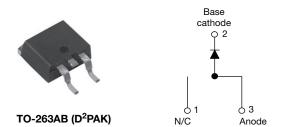
Vishay Semiconductors

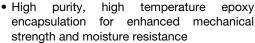
# High Performance Schottky Rectifier, 7.5 A

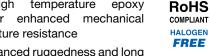


PRODUCT SUMMARY								
Package	TO-263AB (D <sup>2</sup> PAK)  7.5 V  35 V, 45 V  0.57  15 mA at 125 °C  150 °C  Single die							
I <sub>F(AV)</sub>	7.5 V							
$V_{R}$	35 V, 45 V							
V <sub>F</sub> at I <sub>F</sub>	0.57							
I <sub>RM</sub> max.	15 mA at 125 °C							
$T_J$ max.	150 °C							
Diode variation	Single die							
E <sub>AS</sub>	7.0 mJ							

### **FEATURES**

- 150 °C T<sub>J</sub> operation
- · High frequency operation
- · Low forward voltage drop





- · Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201, class 1A whisker
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION**

The VS-MBRB7... Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	SYMBOL CHARACTERISTICS								
I <sub>F(AV)</sub>	Rectangular waveform	7.5	A						
V <sub>RRM</sub>		35, 45	V						
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	690	А						
V <sub>F</sub>	7.5 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.57	V						
T <sub>J</sub>	Range	-65 to +150	°C						

VOLTAGE RATINGS				
PARAMETER	SYMBOL	VS-MBRB735PbF	VS-MBRB745PbF	UNITS
Maximum DC reverse voltage	$V_{R}$	35	45	V
Maximum working peak reverse voltage	$V_{RWM}$	აა	45	V

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST	CONDITIONS	VALUES	UNITS			
Maximum average forward current	I <sub>F(AV)</sub>	$T_C$ = 131 °C, rated $V_R$	7.5					
Non-repetitive peak surge current	I <sub>FSM</sub>	5 μs sine Following any rated load condition and with rated V <sub>RRM</sub> applied		690	А			
		Surge applied at rated load c	150					
Non-repetitive avalanche energy	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 2 A, L = 3.5	7	mJ				
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to Frequency limited by T <sub>J</sub> max	2	А				



# Vishay Semiconductors

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
		15 A	T <sub>J</sub> = 25 °C	0.84				
Maximum forward voltage drop	$V_{FM}$ <sup>(1)</sup>	7.5 A	T <sub>J</sub> = 125 °C	0.57	V			
		15 A	1j = 125 C	0.72				
Maximum instantaneous reverse current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	Dated DC valtage	0.1	mA			
Maximum instantaneous reverse current	IRM (''	T <sub>J</sub> = 125 °C	Rated DC voltage	15				
Maximum junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal ran	400	pF				
Typical series inductance	L <sub>S</sub>	Measured from top of terr	8.0	nH				
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>	10 000	V/µs				

### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction temperature range		$T_J$		-65 to +150	°C			
Maximum storage temperat	ure range	T <sub>Stg</sub>		-65 to +175	- 0			
Maximum thermal resistance, junction to case		$R_{thJC}$	OC operation 3.0		°C/W			
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.50	J/VV			
Approximate weight				2	g			
Approximate weight				0.07	OZ.			
Mounting torque minimum maximum				6 (5)	kgf · cm			
				12 (10)	(lbf $\cdot$ in)			
Marking device			Case style D <sup>2</sup> PAK	MBRB735				
			Case style D-FAR	MBR	B745			

# Vishay Semiconductors

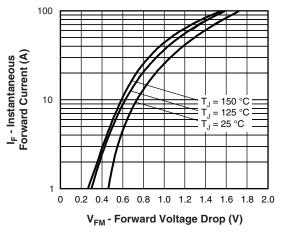


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

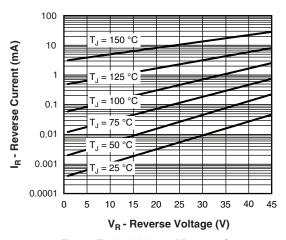


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

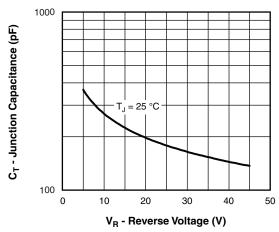


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

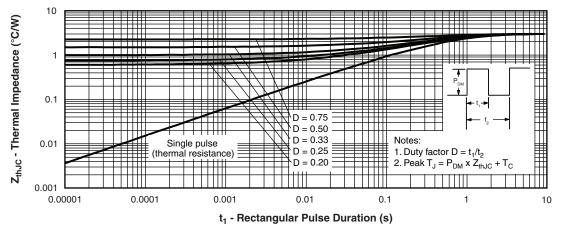


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)

Vishay Semiconductors

www.vishay.com

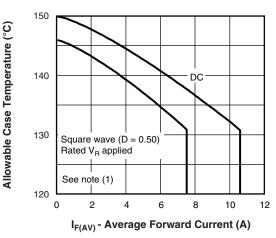


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

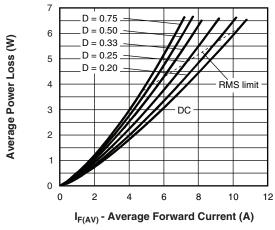


Fig. 6 - Forward Power Loss Characteristics

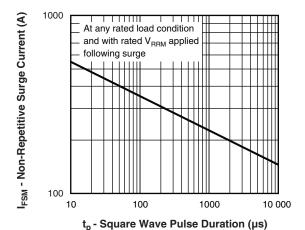


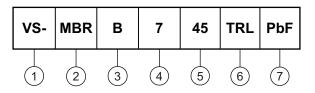
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

### Note

Vishay Semiconductors

### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Essential part number

- • B = surface mount

• None = TO-220

Current rating (7 = 7.5 A)

- Voltage ratings - 35 = 35 V 45 = 45 V

• None = tube (50 pieces)

• TRL = tape and reel (left oriented - for D<sup>2</sup>PAK only)

• TRR = tape and reel (right oriented - for D<sup>2</sup>PAK only)

7 - PbF = lead (Pb)-free

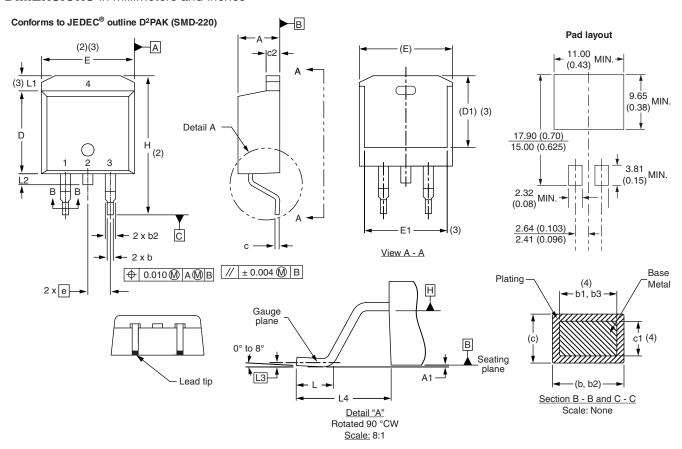
LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95046</u>						
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					
SPICE model	www.vishay.com/doc?95298					



# Vishay Semiconductors

## D<sup>2</sup>PAK

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	ETERS	INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES		STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.